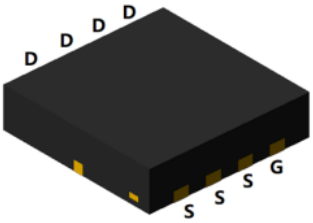
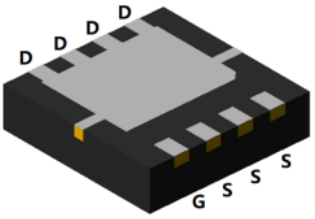
N-Channel Enhancement Mode Field Effect Transistor

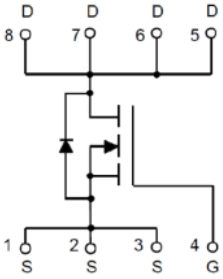


Top View



Bottom View

DFN3333-8L



Product Summary

- V_{DS} 40 V
- I_D 35 A
- $R_{DS(ON)}$(at V_{GS}= 10V) ＜8.0mohm
- $R_{DS(ON)}$(at V_{GS}= 4.5V) ＜13mohm
- 100% EAS Tested
- 100% ▽V_{DS} Tested

General Description

- Trench Power LV MOSFET technology
- Excellent package for heat dissipation
- High density cell design for low $R_{DS(ON)}$
- Epoxy Meets UL 94 V-0 Flammability Rating
- Halogen Free

Applications

- High current load applications
- Load switching
- Hard switched and high frequency circuits
- Uninterruptible power supply

■ Absolute Maximum Ratings (T_A=25℃unless otherwise noted)

Parameter		Symbol	Limit	Unit
Drain-source Voltage		V_{DS}	40	V
Gate-source Voltage		V_{GS}	±20	V
Drain Current	T_C=25℃	I_D	35	A
	T_C=100℃		22	
Pulsed Drain Current [A]		I_{DM}	160	A
Single Pulse Avalanche Energy		E_{AS}	120	mJ
Total Power Dissipation	T_C=25℃	P_D	40	W
	T_A=25℃		1.95	
Thermal Resistance Junction-to-Case		$R_{\theta JC}$	3.1	℃/ W
Thermal Resistance Junction-to-Ambient [B]		$R_{\theta JA}$	64	
Junction and Storage Temperature Range		T_J ,T_{STG}	-55～+150	℃

■ Ordering Information (Example)

PREFERED P/N	PACKING CODE	Marking	MINIMUM PACKAGE(pcs)	INNER BOX QUANTITY(pcs)	OUTER CARTON QUANTITY(pcs)	DELIVERY MODE
Q35N04A	F1	Q35N04	5000	10000	100000	13“ reel

■ Electrical Characteristics (T_J=25℃ unless otherwise noted)

Parameter	Symbol	Conditions	Min	Typ	Max	Units
Static Parameter						
Drain-Source Breakdown Voltage	BV_{DSS}	V_{GS}= 0V, I_D=250μA	40			V
Zero Gate Voltage Drain Current	I_{DSS}	V_{DS}=40V,V_{GS}=0V			1	μA
Gate-Body Leakage Current	I_{GSS}	V_{GS}= ±20V, V_{DS}=0V			±100	nA
Gate Threshold Voltage	$V_{GS(th)}$	V_{DS}= V_{GS}, I_D=250μA	1.0	1.5	2.5	V
Static Drain-Source On-Resistance	$R_{DS(ON)}$	V_{GS}= 10V, I_D=20A		6.5	8.0	mΩ
		V_{GS}= 4.5V, I_D=10A		8.7	13	
Diode Forward Voltage	V_{SD}	I_S=20A,V_{GS}=0V		0.7	1.2	V
Maximum Body-Diode Continuous Current	I_S				35	A
Dynamic Parameters						
Input Capacitance	C_{iss}	V_{DS}=20V,V_{GS}=0V,f=1MHz		1860		pF
Output Capacitance	C_{oss}			256		
Reverse Transfer Capacitance	C_{rss}			205		
Gate Resistance	Rg	f= 1MHz		1.5	2	Ω
Switching Parameters						
Total Gate Charge	Q_g	V_{GS}=10V,V_{DS}=20V,I_D=20A		46.7		nC
Gate-Source Charge	Q_{gs}			8		
Gate-Drain Charge	Q_{gd}			11.6		
Reverse Recovery Charge	Q_{rr}	I_F=20A, di/dt=100A/us		2.3		
Reverse Recovery Time	t_{rr}			15		ns
Turn-on Delay Time	$t_{D(on)}$	V_{GS}=10V,V_{DD}=20V, I_D=20A,R_L=1Ω R_{GEN}=3Ω		10		
Turn-on Rise Time	t_r			21		
Turn-off Delay Time	$t_{D(off)}$			36		
Turn-off fall Time	t_f			25		

A. Pulse Test: Pulse Width≤300us,Duty cycle ≤2%.

B. $R_{\theta JA}$ is the sum of the junction-to-case and case-to-ambient thermal resistance, where the case thermal reference is defined as the solder mounting surface of the drain pins. $R_{\theta JC}$ is guaranteed by design, while $R_{\theta JA}$ is determined by the board design. The maximum rating presented here is based on mounting on a 1 in 2 pad of 2oz copper.

■ Typical Performance Characteristics

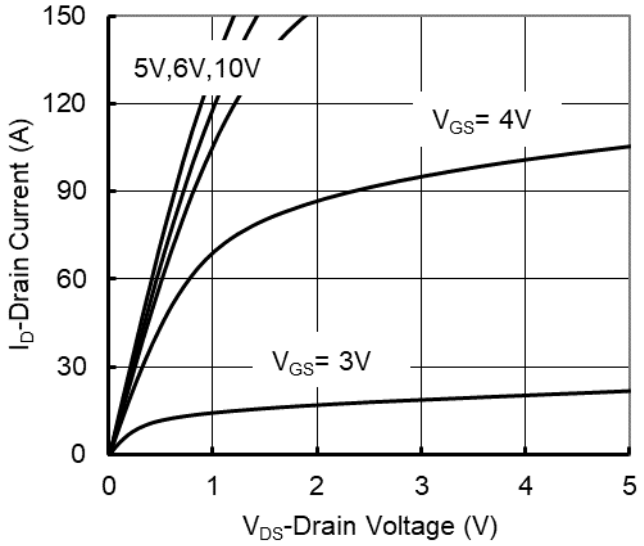


Figure 1. Output Characteristics

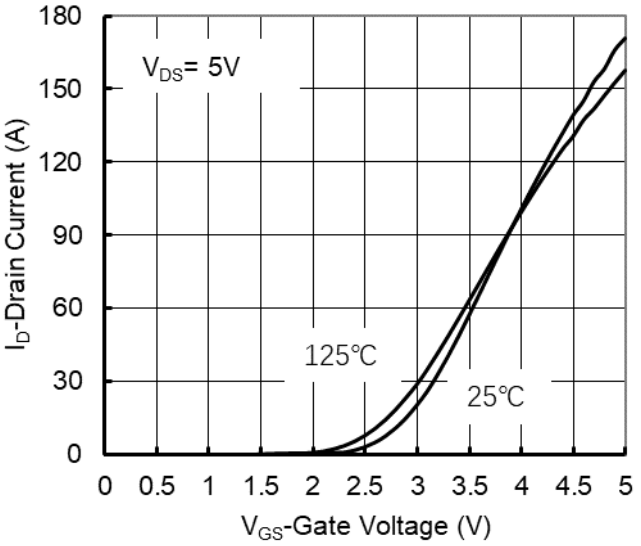


Figure 2. Transfer Characteristics

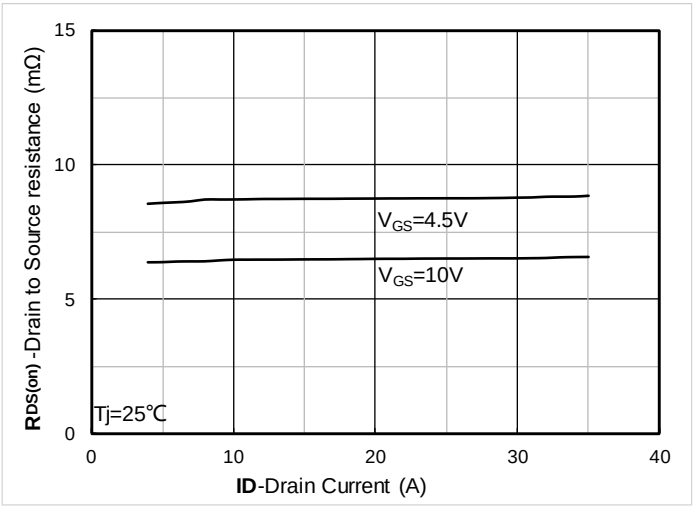


Figure 3. On-Resistance vs. Drain Current and Gate Voltage

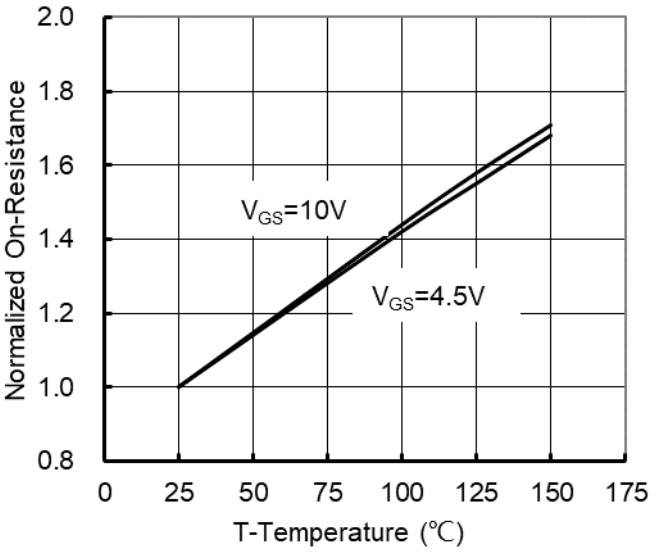


Figure 4. On-Resistance vs. Junction Temperature

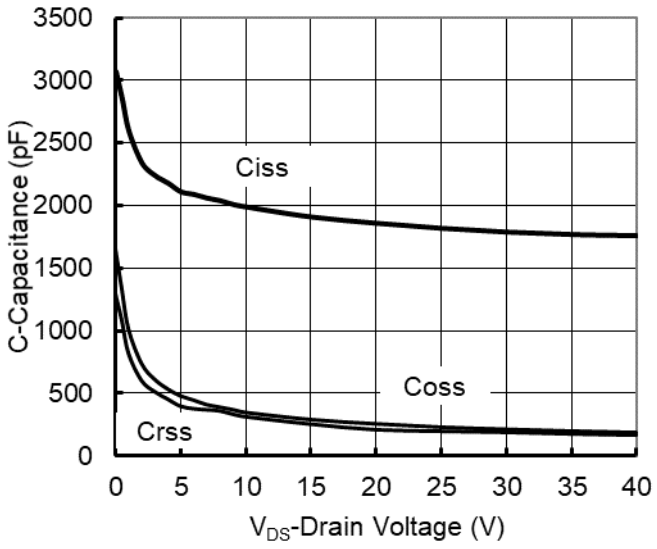


Figure 5. Capacitance Characteristics

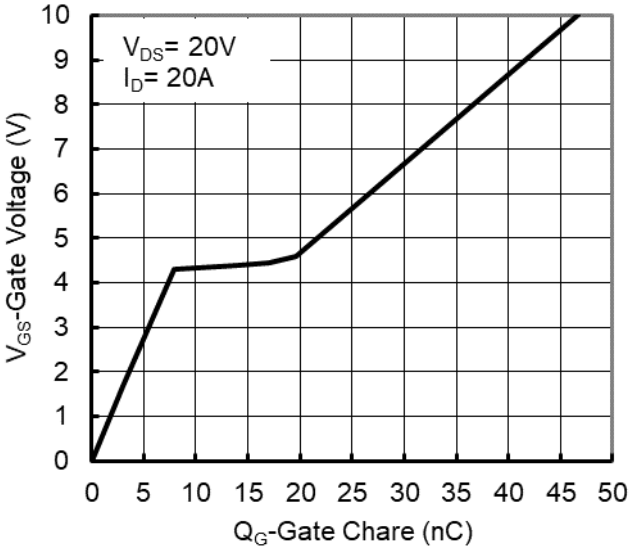


Figure 6. Gate Charge

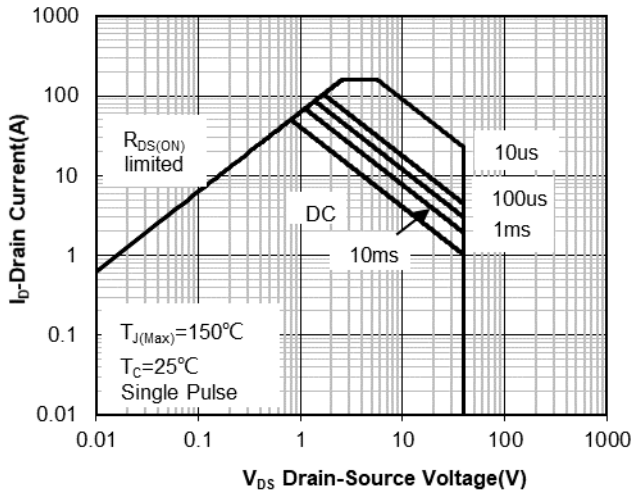


Figure 7. Safe Operation Area

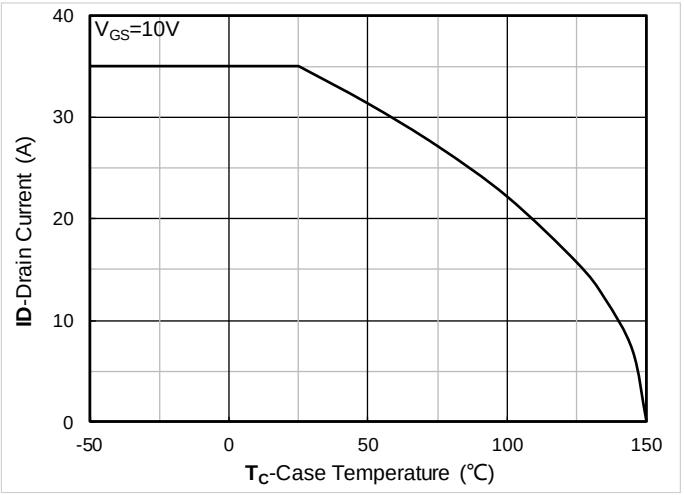


Figure 8. Maximum Continuous Drain Current vs Ambient Temperature

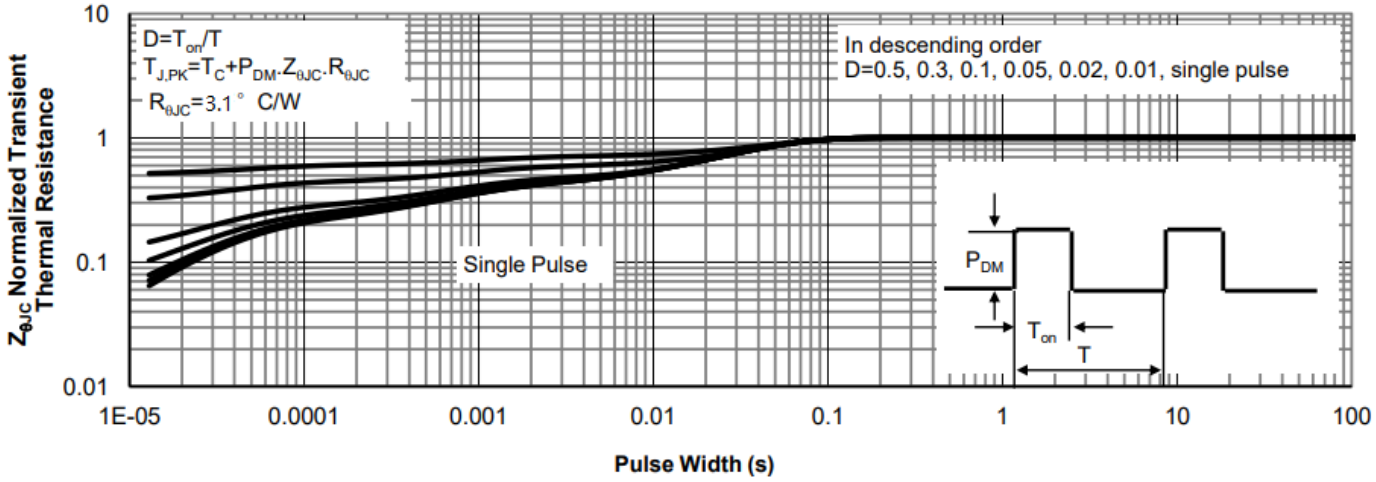
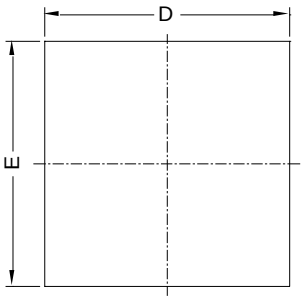
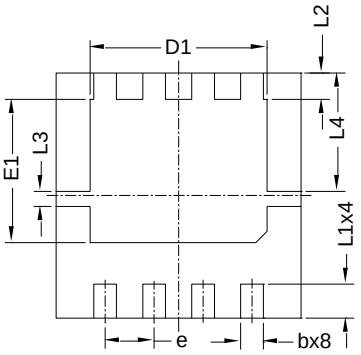


Figure 9. Normalized Maximum Transient Thermal Impedance

■ DFN3333-8L-A-0.8MM Package information



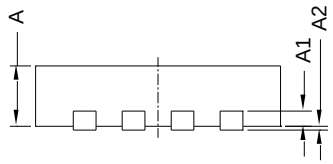
Top View
正面视图



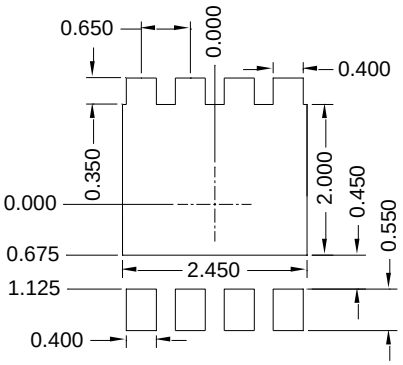
Bottom View
背面视图

SYMBOL	MILLIMETER		
	MIN	NOM	MAX
D	3.15	3.25	3.35
E	3.15	3.25	3.35
A	0.70	0.80	0.90
A1		0.20 BSC	
A2			0.10
D1	2.20	2.35	2.50
E1	1.80	1.90	2.00
L1	0.35	0.45	0.55
L2		0.35 BSC	
L3		0.20 BSC	
L4		1.57 BSC	
b	0.20	0.30	0.40
e		0.65 BSC	

Note:
1.Controlling dimension:in millimeters.
2.General tolerance:±0.10mm.
3.The pad layout is for reference purposes only.



Side View
侧面视图



Suggested Solder Pad Layout
Top View

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